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TD541SCANFD DFN package isolated CAN Transceiver

Features

- · Ultra-small, ultra-thin, chip scale DFN package
- Compliant with ISO11898-2 standard
- Integrate 5V efficiently power supply
- I/O power supply range supports 3.3V and 5V microprocessors
- High isolation to 5000VDC
- Bus-Pin ESD protection up to 15kV(HBM)
- Baud rate up to 5Mbps
- -58V to +58V bus fault protection
- >25kV/us CMTI
- TXD dominant time-out function
- · Low communication delay
- The bus supports maximum 110 nodes
- Industrial operating ambient temperature range: -40°C to +125°C
- Moisture Sensitivity Level (MSL) 3

Applications

- · Industrial automation, control, sensors and drive systems
- Building and greenhouse environmental control(HVAC) automation
- · Security system
- Transport
- Medical treatment
- Telecommunication
- CAN Bus standard such as CAN open, Device Net, NMEA2000, ARNIC825, ISO11783, CAN Kingdom, CAN aerospace

Functional Description

TD541SCANFD is a isolated CANFD Bus transceiver, which is compliant with ISO11898-2 standard. Their logic side supports 3.3V and 5V logic level conversion. TD541SCANFD integrate 5V efficiently power. The TD541SCANFD provide differential transmitting and receiving capability between the CANFD protocol controller and the physical layer bus. It is capable of running at data rates of up to 5Mbps. The device has the function of series line, over-voltage(-58V to 58V), ground loss protection and thermal shutdown so that it is especially suitable for working in harsh environment.

Package



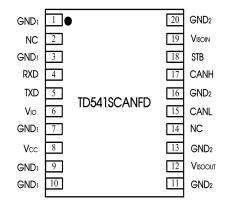


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Pin Connection



Internal Block Diagram

VCC

Transformer

Drive

Signal

Transceiver

Transceiver

CANL

Signal

Transceiver

Transceiver

Transceiver

Transceiver

CANL

Note: All GND1 pins are internally connected; All GND2 pins are internally connected.

Function Table

Letter	Description
Letter	Description
Н	High-Level
L	Low-Level
X	Unrelated
Z	High Impedance

Table 1. Driver Function table

Inp	uts	Outputs		Bus State		
TXD	STB	CANH	CANL	Bus State		
L	L	Н	L	Dominant		
H (Or No Connection)	L	Z	Z	Recessive		
X	Н	Z	Z	Recessive		

Table 2. Receiver Function table

VID=CANH-CANL	RXD	Bus State
VID≥0.9V	L	Dominant
0.5< VID<0.9V	Uncertainty	Uncertainty
VID≤0.5V	Н	Recessive
Open	Н	Recessive

Pin Descriptions

Pin Number	Pin Name	Pin Functions
1	GND₁	Ground(Logic side)
2	NC	No connect
3	GND₁	Ground(Logic side)
4	RXD	Receiver output pin.
5	TXD	Driver input pin
6	V _{IO}	Isolation power supply pin. By using 0.1uF ceramic capacitance ground GND ₁ .
7	GND₁	Ground(Logic side)
8	V _{CC}	Power supply pin. By using 1uF ceramic capacitance ground GND ₁ .
9	GND₁	Ground(Logic side)
10	GND₁	Ground(Logic side)
11	GND ₂	Ground (Bus side)
12	V _{ISOOUT}	Insulation power output. By using 1uF ceramic capacitance ground GND ₂ . The pin needs to be connected to pin19 in application.
13	GND ₂	Ground (Bus side)
14	NC	No connect
15	CANL	CANL pin
16	GND ₂	Ground (Bus side)
17	CANH	CANH pin
18	STB	Standby mode takes control input, this pin connect to ground GND ₂ .
19	V _{ISOIN}	Insulation power input. By using 0.1uF ceramic capacitance ground GND ₂ . The pin needs to be connected to pin12 in application.
20	GND₂	Ground (Bus side)

Absolute Maximum Ratings

General test conditions: Free-air, normal operating temperature range (unless otherwise specified).

Parameters	Unit
Supply voltage, (Vcc)	-0.3V to +5.6V
Digital input voltage (TXD, RXD)	-0.3V to +6V
Bus voltage (CANH, CANL)	-58 to 58V
Receiver output current	-15 to 15mA
Operating temperature range	-40°C to +125°C
Storage temperature range	−50°C to +130°C
Reflow soldering temperature	Peak temp. ≤250°C, maximum duration ≤60s at 217°C. Please also refer to IPC/JEDEC J-STD-020D. 3.

Important: Exposure to absolute maximum rated conditions for an extended period may severely affect the device reliability, and stress levels exceeding the "Absolute Maximum Ratings" may result in permanent damage.

Recommended Operating Conditions

	Parameters				Max.	Unit
Vcc	Po	wer supply	4.75	5	5.25	V
Vio	Power su	pply(Logic Side)	2.75		5.25	V
Vı or Vıc	Voltage at any bus	terminal (differential mode)	-12		12	V
ViH	High-level input voltage	TXD	2			V
VIL	Low-level input voltage	TXD			0.8	V
Lave	Libert Level and a desired	Driver	-70			^
Іон	High-level output current	Receiver V _{CC} =5V	-4			- mA
l	1 1 1 1 1	Driver			70	
lol	Low-level output current	Receiver V _{CC} =5V			4	mA
Та	Operating temperature range		-40		125	°C
Icc	Recessive mode current			20	35	mA

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Icc	Working current	Vcc= 5V,RL= 60Ω ; TXD signal : f=500kHz ; Duty=50%		35	55	mA
	Sig	naling rate	40		5000	kbps

Electrical Characteristics

General test conditions and V_{CC} = V_{IO} = 5V, Ta = 25 $^{\circ}$ C (unless otherwise specified).

	Parameters	Conditions	Min.	Nom.	Max.	Unit
Driver				'		
	Dominant CANH output voltage	F: 0.1/ 0.1/ P 00.0	2.75	3.5	4.5	V
Vo(d)	Dominant CANL output voltage	Figure 8, V_{TXD} = 0 V, R_L = 60 Ω	0.5	1.5	2.25	\ \ \
Vo(R)	Recessive bus voltage	Figure 8, V_{TXD} = 2 V, R_L = 60 Ω	2	2.5	3	V
VOD(D)	Differential output voltage	Figure 8 V_{TXD} = 0V, t < $t_{to(dom)TXD}$, V_{CC} =4.75 V to 5.25 V, RL = 50 to 65 Ω	1.5		3	V
Varia	December differential autout valle se	Figure 8 V_{TXD} = 5 V, RL = 60 Ω	-0.12		0.012	V
Vod(R)	Recessive differential output voltage	V _{TXD} = 5 V,No load	-0.5		0.05	V
Іін	TXD High-level input current	V _{TXD} =2 V			4	uA
lıL	TXD Low-level input current	V _{TXD} =0.8 V	-4			uA
R _{TXD}	Internal TXD Pull up Resistor			9.1		kΩ
Receiver						
VIT+	Positive-going input threshold voltage	Figure 44		750	900	mV
VIT-	Negative-going input threshold voltage	Figure 11	500	650		mV
Vhys	Hysteresis voltage (V _{IT+} - V _{IT-})			120		mV
\/	Liberta Lavarda antino de contra con	Iон = –4 mA, Figure 9	V _{IO} – 0.4	V _{IO} – 0.2		V
Vон	High-level output voltage	Iон = –20 uA, Figure 9	V _{IO} – 0.1			V
Mai	Lavolanda adamta albana	IoL = 4 mA, Figure 9		0.2	0.4	V
Vol	Low-level output voltage	IoL = 20 uA, Figure 9		0	0.1	
Сі	Input capacitance to ground (CANH or CANL)	V_{TXD} = 5 V, VI = 0.4 sin (4E6 π t) + 2.5 V		13		pF
CID	Differential input capacitance	$V_{TXD} = 5 \text{ V}, V_{I} = 0.4 \sin (4E6 \pi t)$		5		pF
Rib	Differential input resistance	V _{TXD} = 5 V	19	30	52	kΩ
Rin	Input resistance (CANH or CANL)	V _{TXD} = 5 V	9	15	28	kΩ
R I(m)	Input resistance matching: $[1 - R_{IN(CANH)}] / R_{IN(CANL)}] \times 100\%$	VCANH = VCANL	-1%	0%	1%	
ESD		CANH, CANL pin to GND			±15	kV
EOD	НВМ	Other pins			±2	kV
EFT	IEC61000-4-4: Perf. Criteria B	CANH, CANL and GND			±2	kV
Surge	IEC61000-4-5 : Perf. Criteria B	CANH, CANL and GND(Common Mode)			±2	kV
	Isolation voltage				5000	VDC
Insulation characteristics	Insulation resistance		1			GΩ
	Isolation capacitor			3		pF
СМТІ	Common Mode Transient Immunity	V _{TXD} = V _{CC} or 0 V, VCM = 1 kV, transient magnitude = 800 V	25			kV/us

	Parameters	Conditions	Min.	Nom.	Max.	Unit
t_{onTXD}	Propagation delay TXD On to bus active			80	150	ns
t _{offTXD}	Propagation delay TXD Off to bus inactive	RL = 60Ω , CL = $100 pF$, see		80	200	ns
t _{onRXD}	Propagation delay RXD On to receiver active	Figure 10 and Figure 12		60	300	ns
t _{offRXD}	Propagation delay RXD Off to receiver inactive			60	250	ns
t _{TXD_OTD}	Dominant time-out time	CL=100 pF		2	5	ms

Physical Specifications

Parameters	Value	Unit
Weight	0.9(Typ.)	g

Typical Performance Curves

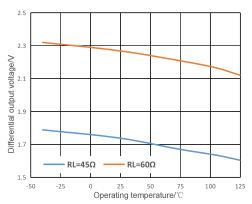


Figure 1. Drive differential output voltage dominant VS Operating Temperature

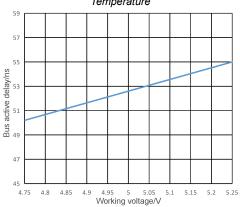


Figure 3. Propagation delay from TXD On to bus active VS Working voltage

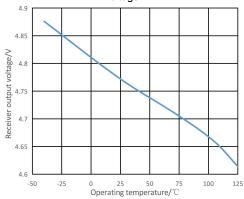


Figure 5. Propagation delay from TXD On to receiver active VS Operating Temperature

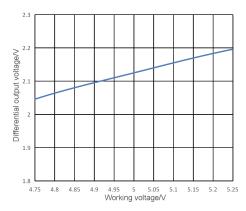


Figure 2. Drive differential output voltage dominant VS Working voltage

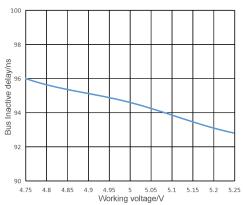


Figure 4. Propagation delay from TXD Off to bus inactive VS Working voltage

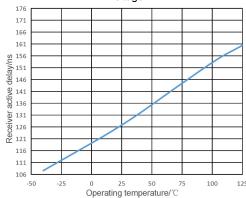


Figure 6. Receiver active delay VS Operating Temperature

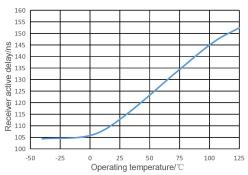
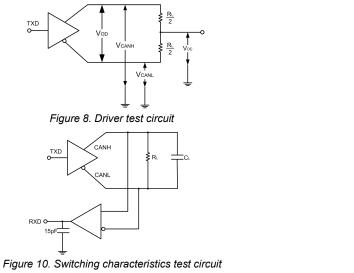


Figure 7. Receiver inactive delay VS Operating Temperature

Test Circuits



CANH O VID CANL O RXE

Figure 9 Receiver test circuit

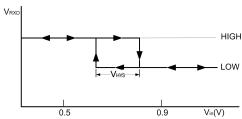


Figure 11. Receiver input hysteresis

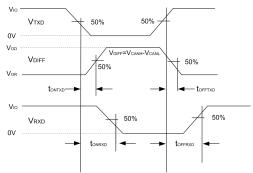


Figure 12. Drive and receiver propagation delay

Detailed Description

TD541SCANFD is a CAN of a style of separation transceiver with the ability of differential signal transmission between the bus and CAN protocol controller, it the inner integration insulate DC/DC power supply.which is compliant with ISO11898-2 standard.

Short-circuit protection: TD541SCANFD has current-limiting protection to prevent the drive circuit from short-circuiting to positive and negative supply voltages. The power dissipation increases when a short circuit occurs. The short-circuit protection function protects the driver stage from damage.

Over-temperature protection: TD541SCANFD has over-temperature protection. When the junction temperature exceeds 160°C, the current in the driver stage will decrease. Because the drive tube is the primary energy consuming component, current reduction can reduce power consumption and reduce chip temperature. At the same time, the rest of the chip remains functional.

Dominant time-out function: TD541SCANFD has dominant time-out function to prevent if the pin TXD is forced to a permanent low level due to a hardware or software application failure, the built-in TXD dominant timeout timer circuit prevents the bus line from being driven to a permanent dominant state (blocking all network traffic). The timer is triggered by the negative edge on pin TXD, If the low level on pin TXD lasts longer than the internal timer value (t_{TXD_OTD}), the transmitter will be disabled and the drive bus will enter a recessive state. The timer is reset by the positive edge on pin TXD.

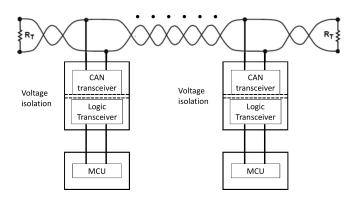


Figure 13. Typical application circuit

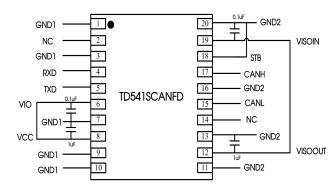


Figure 14. Typical Application of PCB layout

In General, V_{CC} and V_{IO} can be shorted(Figure 14) if the controller doesn't support 5V signal input, it can power 3.3V for V_{IO} . When the module is in normal condition attach STB Pin to GND2

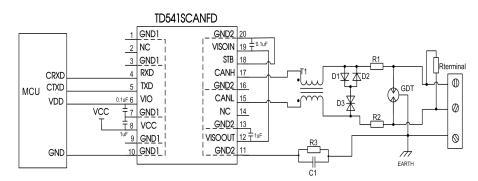


Figure 15. Port protection circuit for harsh environments

Recommended components and values:

Component	Recommended part, value	Component	Recommended part, value		
R3	1ΜΩ	D1、D2	1N4007		
C1	1nF, 2kV	D3	SMBJ30CA		
T1	ACM2520-301-2P	R _{terminal}	120Ω		
GDT	B3D090L	R1、R2	2.7Ω/2W		

When the module is used in applications with harsh environment, it can be susceptible to large energy like lightning strike, etc. in which case, it is essential to add an adequate protection circuit to the CAN signal ports to protect the system from failure and maintain a reliable bus communication. Figure 15 provides a recommended protection circuit design for high-energy lightning surges, with a degree of protection related to the selected protection device. Parameter description lists a set of recommended circuit parameters, which can be adjusted according to the actual application situation. Also, when using the shielded cable, the reliable single-point grounding of the shield must be achieved.

Note: The recommended components and values is a general guideline only and must be verified for the actual user's application. We recommended using PTC's for R1 and R2 and to use fast recovery diodes for D1 and D2.

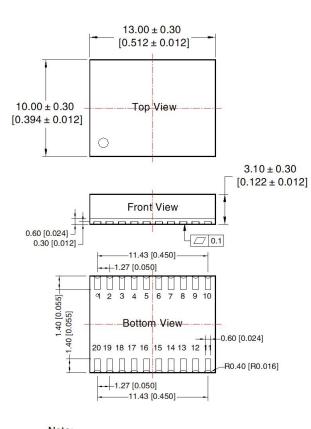
Using Suggests

- ① Power isolation V_{ISOIN} need through a series of capacitors connected to the output pin V_{ISOIN} , the power supply is not recommended for other purposes, otherwise it may cause the bus voltage did not meet the requirements of communication, causes the communication failure.
- ② Hot-swap is not supported.
- 3 If the external input of TXD is insufficient, the pull-up resistor should be added according to the situation.
- Refer to IPC 7093 for the welding process design of this product. For detailed operation guidance, please refer to Hot Air Gun Welding Operation
 Instruction for DFN Package Product or Welding Operation Instruction for DFN Package Product.

Ordering Information

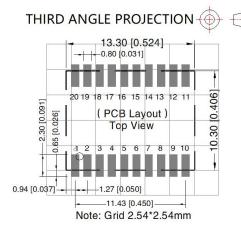
Part number	Package	Number of pins	Product marking	Tape & Reel	
TD541SCANFD	DFN	20	TD541SCANFD	300/RELL	

Package Information

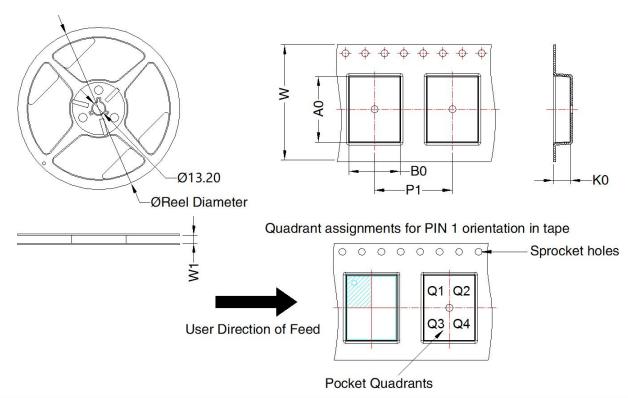


Note: Unit: mm[inch]

Pin diameter tolerances: ± 0.10[± 0.004]



Pin-Out							
Pin	Mark	Pin	Mark				
1	GND₁	11	GND ₂				
2	NC	12	VISCOUT				
3	GND₁	13	GND₂ NC				
4	RXD	14					
5	TXD	15	CANL				
6	Vio	16	GND₂				
7	GND₁	17	CANH				
8	Vcc	18	S				
9	GND₁	19	VISOIN				
10	10 GND ₁		GND ₂				



Device	Package Type	Pin	MPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TD541SCANFD	DFN 10x13	20	300	180.0	24.4	13.52	10.52	3.5	16.0	24.0	Q1

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